Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

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We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!


## Contact us

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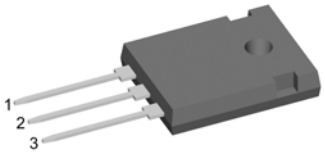
# Schottky Diode Gen ²

$V_{RRM}$ = 100V
$I_{FAV}$ = 2x 25A
$V_F$ = 0.72V

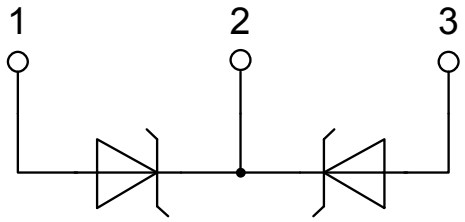
High Performance Schottky Diode
Low Loss and Soft Recovery
Common Cathode

**Part number**

DSA50C100HB




Backside: cathode




**Features / Advantages:**

- Very low Vf
- Extremely low switching losses
- Low Irm values
- Improved thermal behaviour
- High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- Low noise switching

**Applications:**

- Rectifiers in switch mode power supplies (SMPS)
- Free wheeling diode in low voltage converters

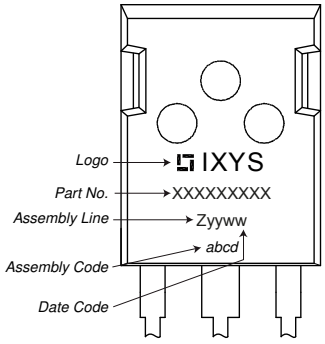
**Package:** TO-247

- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0

| Schottky | | | | Ratings | | | |
|---|---|---|---|---|---|---|---|
| Symbol | Definition | Conditions | | min. | typ. | max. | Unit |
| $V_{RSM}$ | *max. non-repetitive reverse blocking voltage* | | $T_{VJ}$ = 25°C | | | 100 | V |
| $V_{RRM}$ | *max. repetitive reverse blocking voltage* | | $T_{VJ}$ = 25°C | | | 100 | V |
| $I_R$ | *reverse current, drain current* | $V_R$ = 100 V | $T_{VJ}$ = 25°C | | | 450 | µA |
| | | $V_R$ = 100 V | $T_{VJ}$ = 125°C | | | 5 | mA |
| $V_F$ | *forward voltage drop* | $I_F$ = 25 A | $T_{VJ}$ = 25°C | | | 0.90 | V |
| | | $I_F$ = 50 A | | | | 1.07 | V |
| | | $I_F$ = 25 A | $T_{VJ}$ = 125°C | | | 0.72 | V |
| | | $I_F$ = 50 A | | | | 0.90 | V |
| $I_{FAV}$ | *average forward current* | $T_C$ = 155°C | $T_{VJ}$ = 175°C | | | 25 | A |
| | | rectangular d = 0.5 | | | | | |
| $V_{F0}$ | *threshold voltage* } *for power loss calculation only* | | $T_{VJ}$ = 175°C | | | 0.45 | V |
| $r_F$ | *slope resistance* } | | | | | 7.3 | mΩ |
| $R_{thJC}$ | *thermal resistance junction to case* | | | | | 0.95 | K/W |
| $R_{thCH}$ | *thermal resistance case to heatsink* | | | | 0.25 | | K/W |
| $P_{tot}$ | *total power dissipation* | | $T_C$ = 25°C | | | 160 | W |
| $I_{FSM}$ | *max. forward surge current* | t = 10 ms; (50 Hz), sine; $V_R$ = 0 V | $T_{VJ}$ = 45°C | | | 440 | A |
| $C_J$ | *junction capacitance* | $V_R$ = 12 V f = 1 MHz | $T_{VJ}$ = 25°C | | 289 | | pF |

| Package TO-247 | | | Ratings | | | |
|---|---|---|---|---|---|---|
| Symbol | Definition | Conditions | min. | typ. | max. | Unit |
| $I_{RMS}$ | *RMS current* | per terminal [1] | | | 50 | A |
| $T_{VJ}$ | *virtual junction temperature* | | -55 | | 175 | °C |
| $T_{op}$ | *operation temperature* | | -55 | | 150 | °C |
| $T_{stg}$ | *storage temperature* | | -55 | | 150 | °C |
| Weight | | | | 6 | | g |
| $M_D$ | *mounting torque* | | 0.8 | | 1.2 | Nm |
| $F_C$ | *mounting force with clip* | | 20 | | 120 | N |

Product Marking



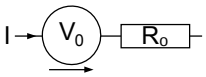

**Part number**

D = Diode
S = Schottky Diode
A = low VF
50 = Current Rating [A]
C = Common Cathode
100 = Reverse Voltage [V]
HB = TO-247AD (3)

| Ordering | Part Number | Marking on Product | Delivery Mode | Quantity | Code No. |
|---|---|---|---|---|---|
| Standard | DSA50C100HB | DSA50C100HB | Tube | 30 | 502774 |

| Similar Part | Package | Voltage class |
|---|---|---|
| DSA50C100QB | TO-3P (3) | 100 |
| DSA60C100PB | TO-220AB (3) | 100 |

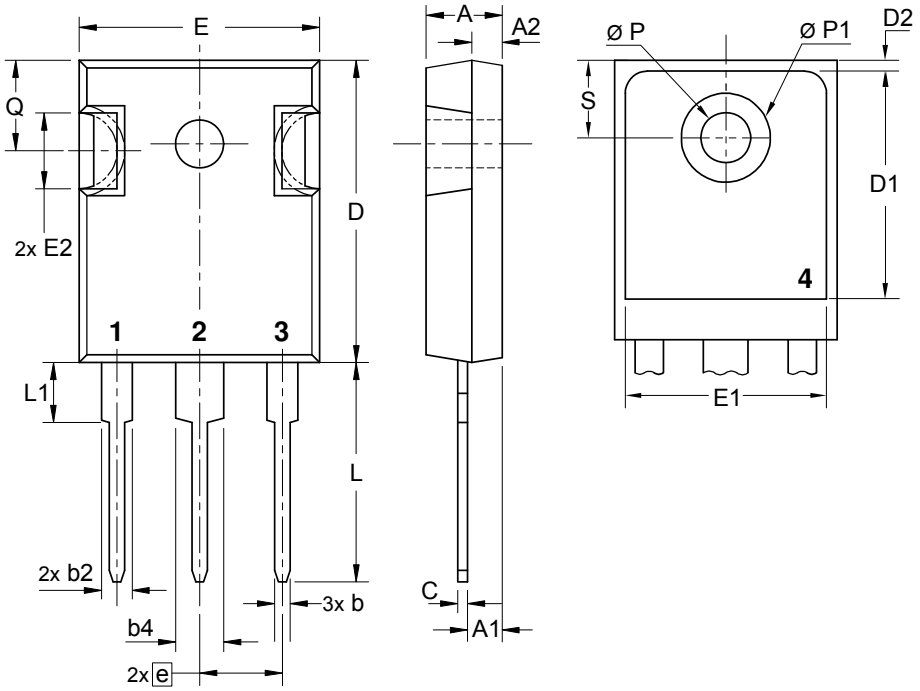
**Equivalent Circuits for Simulation** ** on die level* $T_{VJ}$ = 175 °C



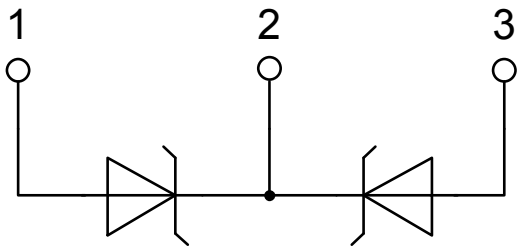

Schottky

| | | | |
|---|---|---|---|
| $V_{0\,max}$ | *threshold voltage* | 0.45 | V |
| $R_{0\,max}$ | *slope resistance ** | 4.7 | mΩ |

## Outlines TO-247




| Sym. | Inches | | Millimeter | |
|---|---|---|---|---|
| | min. | max. | min. | max. |
| A | 0.185 | 0.209 | 4.70 | 5.30 |
| A1 | 0.087 | 0.102 | 2.21 | 2.59 |
| A2 | 0.059 | 0.098 | 1.50 | 2.49 |
| D | 0.819 | 0.845 | 20.79 | 21.45 |
| E | 0.610 | 0.640 | 15.48 | 16.24 |
| E2 | 0.170 | 0.216 | 4.31 | 5.48 |
| e | 0.215 BSC | | 5.46 BSC | |
| L | 0.780 | 0.800 | 19.80 | 20.30 |
| L1 | - | 0.177 | - | 4.49 |
| Ø P | 0.140 | 0.144 | 3.55 | 3.65 |
| Q | 0.212 | 0.244 | 5.38 | 6.19 |
| S | 0.242 BSC | | 6.14 BSC | |
| b | 0.039 | 0.055 | 0.99 | 1.40 |
| b2 | 0.065 | 0.094 | 1.65 | 2.39 |
| b4 | 0.102 | 0.135 | 2.59 | 3.43 |
| c | 0.015 | 0.035 | 0.38 | 0.89 |
| D1 | 0.515 | - | 13.07 | - |
| D2 | 0.020 | 0.053 | 0.51 | 1.35 |
| E1 | 0.530 | - | 13.45 | - |
| Ø P1 | - | 0.29 | - | 7.39 |



## Schottky

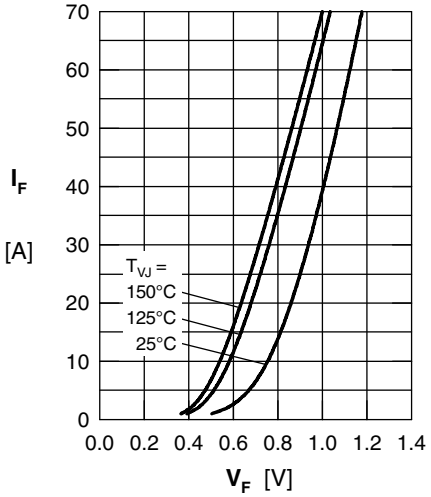



Fig. 1 Maximum forward voltage drop characteristics

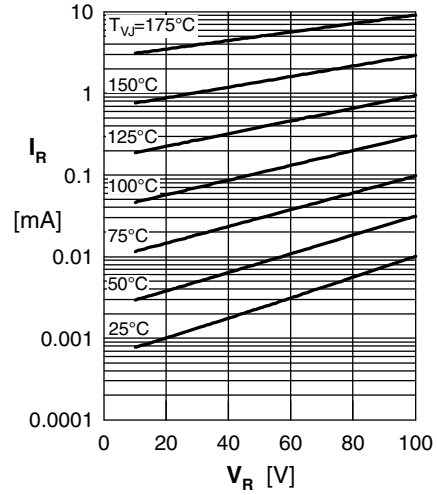



Fig. 2 Typ. reverse current $I_R$ vs. reverse voltage $V_R$

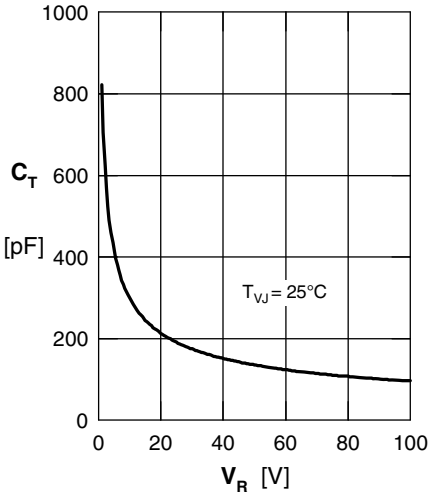



Fig. 3 Typ. junction capacitance $C_T$ vs. reverse voltage $V_R$

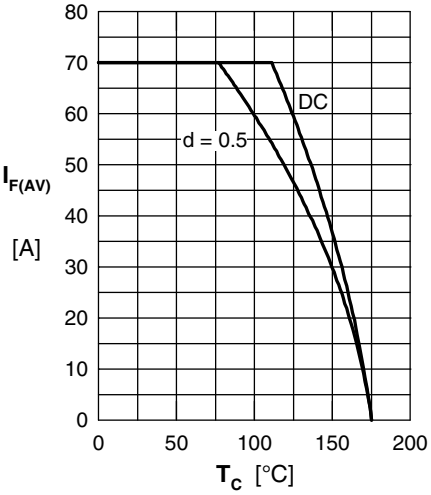



Fig. 4 Average forward current $I_{F(AV)}$ vs. case temperature $T_C$

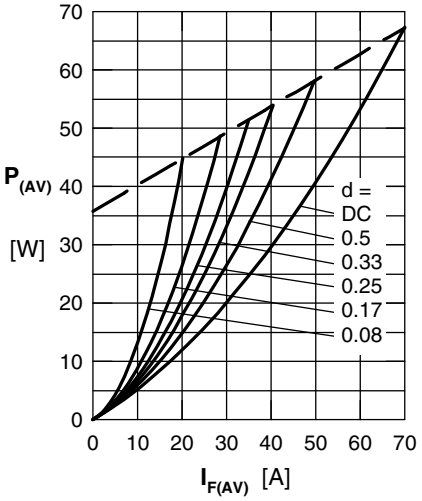



Fig. 5 Forward power loss characteristics

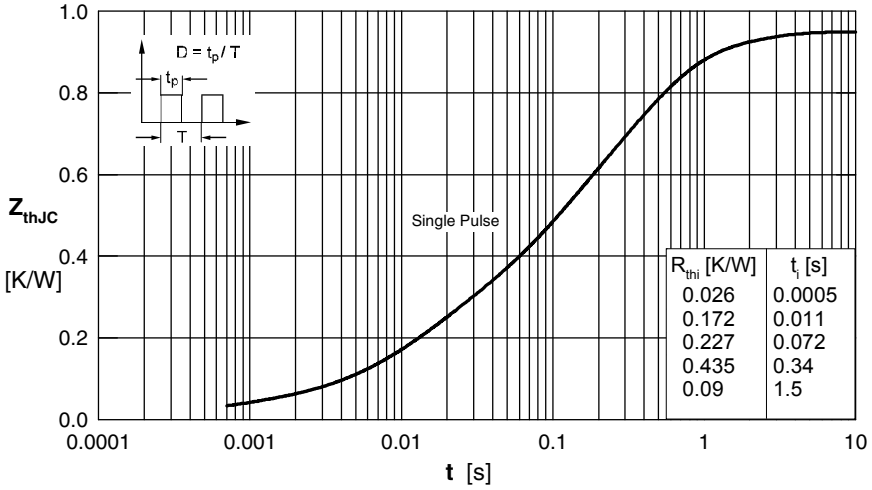



Fig. 6 Transient thermal impedance junction to case

Note: All curves are per diode